

RE CITATION
KODAK
APR 29 2004
U.S. PATENT & TRADEMARK OFFICE

U. S. PATENT DOCUMENTS

10/780, 512

Tai - Chun Huang et al.

02/17/04

Q. How many units?

[illegible]

OTHER DOCUMENTS (Including Author, Title, Date, Portion of Page, Etc.)

C.C.	-	Co-pending U.S. Patent App. Serial No. 09/989,837, filed on 11/20/01, assigned to the same assignee, "RF Seal Ring Structure".
C.C.	-	U.S. Patent App. Pub. US 2001/0030358 A1 to Okada et al. Pub. Date 10/18/01, Filed 02/28/01, U.S.C. 257/678, "Semiconductor Device Package".
EXAMINED	1	DATE CONSIDERED

ΔΙΛΥΝΕΝ

DATE COMPLETED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.